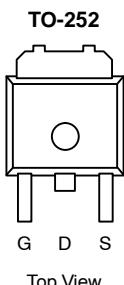


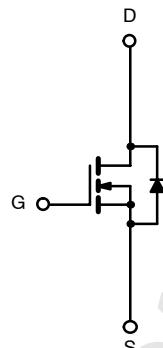
## N-Channel 22-V (D-S) 175°C MOSFET

<b>PRODUCT SUMMARY</b>		
$V_{DS}$ (V)	$r_{DS(on)}$ ( $\Omega$ )	$I_D$ (A) <sup>d</sup>
$24^{\circ}\text{C}$	0.0095 @ $V_{GS} = 10\text{ V}$	49
	0.017 @ $V_{GS} = 4.5\text{ V}$	36



Drain Connected to Tab

Top View



Ordering Information: SUD50N024-09P  
SUD50N024-09P—E3 (Lead Free)

N-Channel MOSFET

### FEATURES

- TrenchFET® Power MOSFET
- 175°C Junction Temperature
- PWM Optimized for High Efficiency

### APPLICATIONS

- High-Side Synchronous Buck DC/DC Conversion
  - Desktop
  - Server

<b>ABSOLUTE MAXIMUM RATINGS (T<sub>A</sub> = 25°C UNLESS OTHERWISE NOTED)</b>				
Parameter		Symbol	Limit	Unit
Drain-Source Pulse Voltage		$V_{DS(\text{pulse})}$	24 <sup>c</sup>	V
Drain-Source Voltage		$V_{DS}$	22	
Gate-Source Voltage		$V_{GS}$	$\pm 20$	
Continuous Drain Current <sup>a</sup>	$T_C = 25^{\circ}\text{C}$	$I_D$	49d	A
	$T_C = 100^{\circ}\text{C}$		34 <sup>d</sup>	
Pulsed Drain Current		$I_{DM}$	100	
Continuous Source Current (Diode Conduction) <sup>a</sup>		$I_S$	4.3	
Avalanche Current, Single Pulse	$L = 0.1\text{ mH}$	$I_{AS}$	29	
Avalanche Energy, Single Pulse		$E_{AS}$	42	mJ
Maximum Power Dissipation	$T_A = 25^{\circ}\text{C}$	$P_D$	6.5 <sup>a</sup>	W
	$T_C = 25^{\circ}\text{C}$		39.5	
Operating Junction and Storage Temperature Range		$T_J, T_{stg}$	-55 to 175	°C

<b>THERMAL RESISTANCE RATINGS</b>					
Parameter		Symbol	Typical	Maximum	Unit
Maximum Junction-to-Ambient <sup>a</sup>	$t \leq 10\text{ sec}$	$R_{thJA}$	19	23	°C/W
	Steady State		40	50	
Maximum Junction-to-Case		$R_{thJC}$	3.1	3.8	

Notes

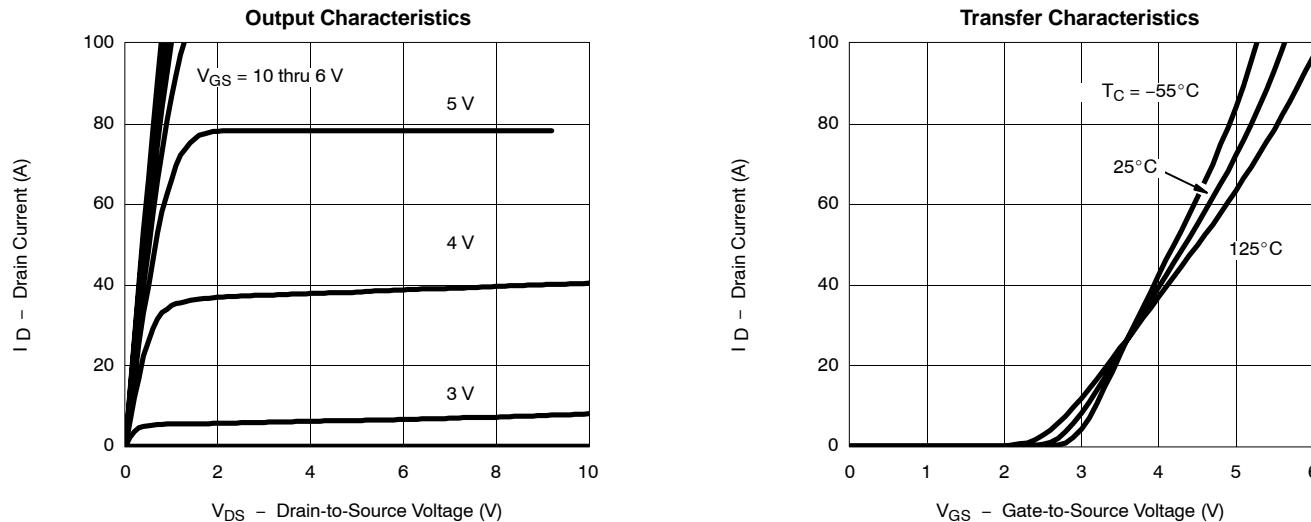
- Surface Mounted on FR4 Board,  $t \leq 10\text{ sec}$ .
- Limited by package
- Pulse condition:  $T_A = 105^{\circ}\text{C}$ , 50 ns, 300 kHz operation
- Calculation based on maximum allowable Junction Temperature. Package limitation current is 25 A.

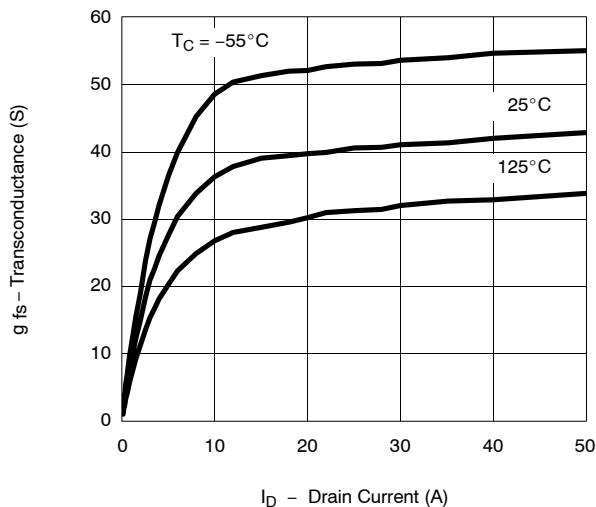
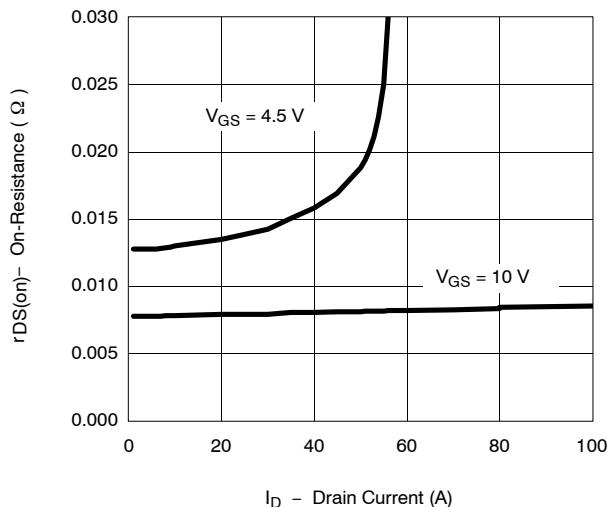
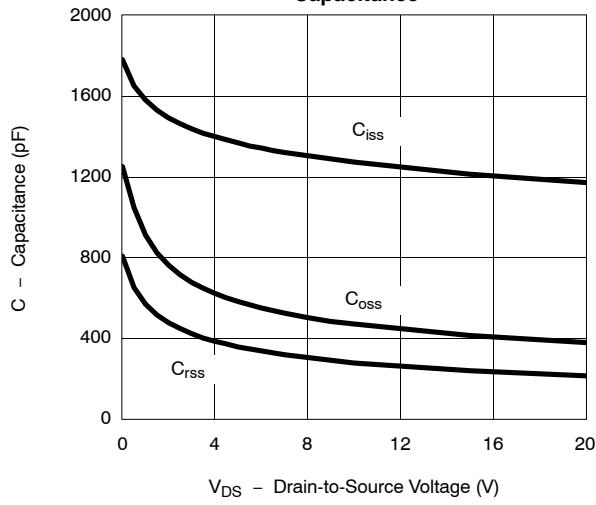
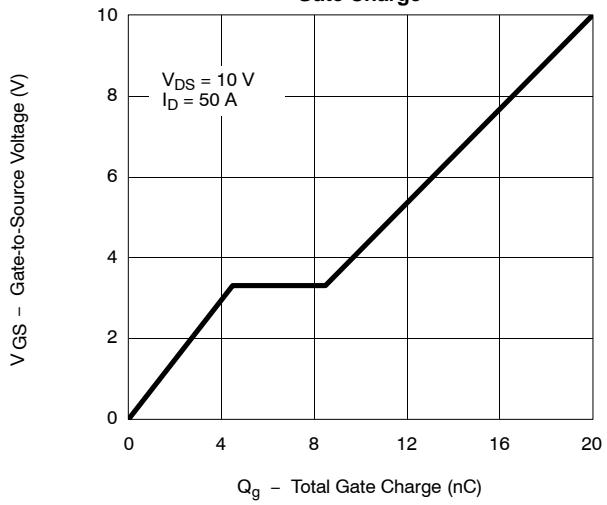
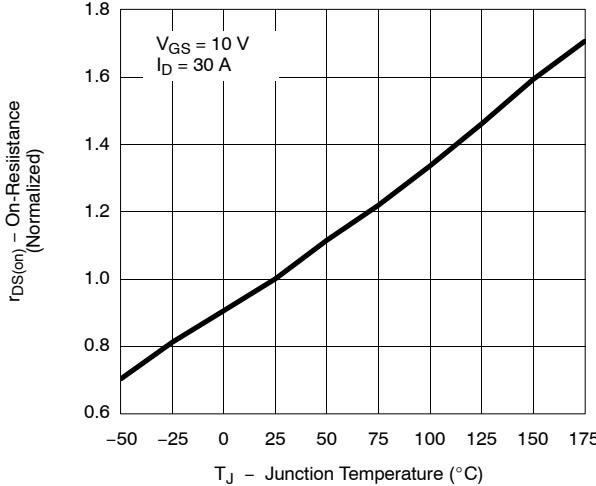
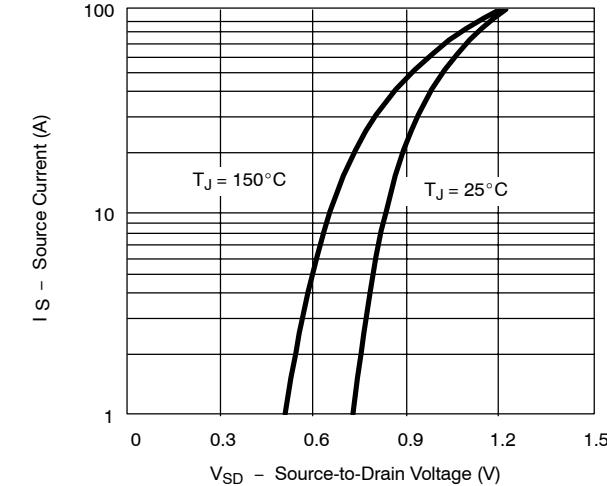
**SPECIFICATIONS ( $T_J = 25^\circ\text{C}$  UNLESS OTHERWISE NOTED)**

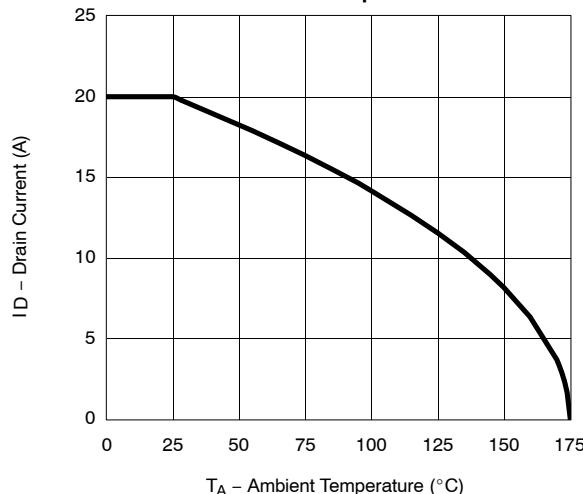
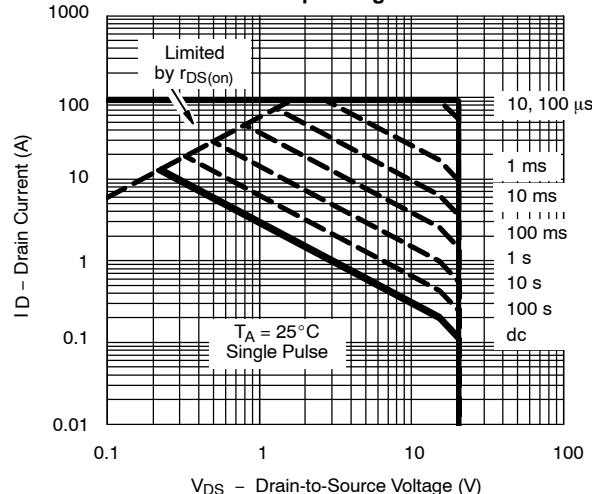
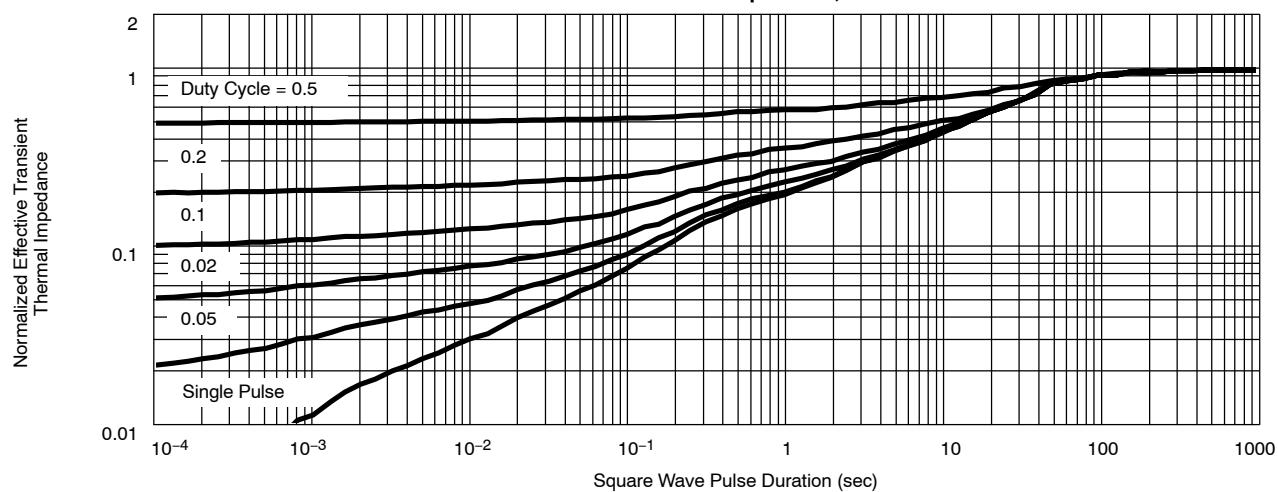
Parameter	Symbol	Test Condition	Min	Typ <sup>a</sup>	Max	Unit
<b>Static</b>						
Drain-Source Breakdown Voltage	$V_{(\text{BR})\text{DSS}}$	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	22			V
Gate Threshold Voltage	$V_{GS(\text{th})}$	$V_{DS} = V_{GS}, I_D = 250 \mu\text{A}$	0.8		3.0	
Gate-Body Leakage	$I_{GSS}$	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			$\pm 100$	nA
Zero Gate Voltage Drain Current	$I_{DSS}$	$V_{DS} = 20 \text{ V}, V_{GS} = 0 \text{ V}$		1		$\mu\text{A}$
		$V_{DS} = 20 \text{ V}, V_{GS} = 0 \text{ V}, T_J = 125^\circ\text{C}$		50		
On-State Drain Current <sup>b</sup>	$I_{D(\text{on})}$	$V_{DS} = 5 \text{ V}, V_{GS} = 10 \text{ V}$	50			A
Drain-Source On-State Resistance <sup>b</sup>	$r_{DS(\text{on})}$	$V_{GS} = 10 \text{ V}, I_D = 20 \text{ A}$		0.008	0.0095	
		$V_{GS} = 10 \text{ V}, I_D = 20 \text{ A}, T_J = 125^\circ\text{C}$			0.014	
		$V_{GS} = 4.5 \text{ V}, I_D = 20 \text{ A}$		0.0135	0.017	
Forward Transconductance <sup>b</sup>	$g_{fs}$	$V_{DS} = 15 \text{ V}, I_D = 20 \text{ A}$	15			S
<b>Dynamic<sup>a</sup></b>						
Input Capacitance	$C_{iss}$	$V_{GS} = 0 \text{ V}, V_{DS} = 10 \text{ V}, f = 1 \text{ MHz}$		1300		
Output Capacitance	$C_{oss}$			470		pF
Reverse Transfer Capacitance	$C_{rss}$			275		
Gate Resistance	$R_g$	$V_{DS} = 10 \text{ V}, V_{GS} = 4.5 \text{ V}, I_D = 50 \text{ A}$	1.6	4.0	6	$\Omega$
Total Gate Charge <sup>c</sup>	$Q_g$			10.5	16	
Gate-Source Charge <sup>c</sup>	$Q_{gs}$			4.2		nC
Gate-Drain Charge <sup>c</sup>	$Q_{gd}$			4.0		
Turn-On Delay Time <sup>c</sup>	$t_{d(\text{on})}$	$V_{DD} = 10 \text{ V}, R_L = 0.2 \Omega$ $I_D \approx 50 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 2.5 \Omega$		8	12	
Rise Time <sup>c</sup>	$t_r$			10	15	
Turn-Off Delay Time <sup>c</sup>	$t_{d(\text{off})}$			25	40	
Fall Time <sup>c</sup>	$t_f$			12	20	ns
<b>Source-Drain Diode Ratings and Characteristic (<math>T_C = 25^\circ\text{C}</math>)</b>						
Pulsed Current	$I_{SM}$				100	A
Diode Forward Voltage <sup>b</sup>	$V_{SD}$	$I_F = 50 \text{ A}, V_{GS} = 0 \text{ V}$		1.2	1.5	V
Source-Drain Reverse Recovery Time	$t_{rr}$	$I_F = 50 \text{ A}, dI/dt = 100 \text{ A}/\mu\text{s}$		35	70	ns

## Notes

- a. Guaranteed by design, not subject to production testing.
- b. Pulse test; pulse width  $\leq 300 \mu\text{s}$ , duty cycle  $\leq 2\%$ .
- c. Independent of operating temperature.

**TYPICAL CHARACTERISTICS ( $25^\circ\text{C}$  UNLESS NOTED)**

**TYPICAL CHARACTERISTICS (25°C UNLESS NOTED)**
**Transconductance**

**On-Resistance vs. Drain Current**

**Capacitance**

**Gate Charge**

**On-Resistance vs. Junction Temperature**

**Source-Drain Diode Forward Voltage**


**THERMAL RATINGS****Maximum Drain Current vs.  
Ambient Temperature****Safe Operating Area****Normalized Thermal Transient Impedance, Junction-to-Ambient**



## Legal Disclaimer Notice

Vishay

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